866 741 0075

NO. 2146 P. 1

Docket No. 740819-1034

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Toshikazu ONISHI

Application No. 10/713,220

Filed: November 17, 2003

For: Semiconductor laser device and method for

Fabricating the same

) ATTENTION:

OFFICE OF INITIAL PATENT

) EXAMINATION'S FILIN

) RECEIPT CORRECTION

) Group Art Unit: 2811

CERTIFICATE OF TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office:

Fax No. (703) 746-9195 on January , 2005

Eddie et uz.

REQUEST FOR CORRECTED OFFICIAL FILING RECEIP

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Enclosed is a copy of the Official Filing Receipt marked to show a correction that is needed.

The correction is as follows:

The Power of Attorney says "None" and this should be:

- The patent practitioners associated with Customer Number 22204--.

Issuance of a corrected Official Filing Receipt is respectfully requested.

Respectfully submitted,

3y:_______

Donald R. Studebaker Registration No. 32,815

NIXON PEABODY LLP

401 9TH Street, N.W., Suite 900

Washington D.C. 20004-2128

Telephone: 202-585-8234

Date: January 25, 2005

W630857.1



United States Patent and Trademark Office

UNITED STATES DEFARTMENT OF COMMERCE United States Patent ed Trudopueli Office Address COMMISSIONER FOR PATENTS

P.O. Box 1430 Alexandria, Vignosa 2113-1450 www.sapio.gov

FILING OR 371 DRAWNGS FIL FEE REC'D ATTY. DOCKET NO TOT CLMS IND CLMS ART UNIT APPL NO. (c) DATE 910 740819-1034 23 2811

MON 3 & 5000

10/713.220 11/17/2003

CON用RMATION NO. 2736

UPDATED FILING RECEIPT

OC000000014433573

22204 NIXON PEABODY, LLP 401 9TH STREET, NW SUITE 900 WASHINGTON, DC 20004-2128

Dake Mailed: 11/23/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its 6 der and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE. NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Toshikazu Onishi, Kyoto, JAPAN;

Assignment For Published Patent Application

Matsushita Electric Industrial Co., Ltd., Osaka, JAPAN

Power of Attorney: None

with Customer No. 22204 --The patent practitioners Associated Domestic Priority data as claimed by applicant

This application is a DIV of 09/784,016 02/16/2001 PAT 6,661,824

Foreign Applications

JAPAN 2000-041558 02/18/2000 JAPAN 2000-102234 04/04/2000

If Required, Foreign Filing License Granted: 09/15/2004

The country code and number of your priority application, to be used for filing abroat under the Paris Convention, is US10/713,220

Projected Publication Date: 03/03/2005

Non-Publication Request: No.

PAGE 2/3 * RCVD AT 1/25/2005 4:34:01 PM [Eastern Standard Time] * SVR:USPTO-EFXRF-2/0 * DNIS:7469195 * CSID:866 741 0075 * DURATION (mm-ss):01-14

Early Publication Request: No

Title

Semiconductor laser device and method for fabricating the same

Preliminary Class

438

LICENSE FOR FOREIGN FILING UNDER Title 35, United States Code, Section 184 Title 37, Code of Federal Regulations, 5.11 & 5.15

GRANTED

The applicant has been granted a license under 35 U.S.C. 184, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" followed by a date appears on this form. Such licenses are issued in all applications where the conditions for issuance of a license have been met, regardless of whether or not a license may be required as set forth in 37 CFR 5.15. The scope and limitations of this license are set forth in 37 CFR 5.15(a) unless an earlier license has been issued under 37 CFR 5.15(b). The license is subject to revocation upon written notification. The date indicated is the effective date of the license, unless an earlier license of similar scape has been granted under 37 CFR 5.13 or 5.14.

This license is to be retained by the licensee and may be used at any time on or after the effective date thereof unless it is revoked. This license is automatically transferred to any related applications(ϵ) filed under 37 CFR 1.53(d). This license is not retroactive.

The grant of a license does not in any way lessen the responsibility of a licensee for the pecurity of the subject matter as imposed by any Government contract or the provisions of existing laws relating to espionage and the national security or the export of technical data. Licensees should apprise themselves of current regulations especially with respect to certain countries, of other agencies, particularly the Office of De ense Trade Controls, Department of State (with respect to Arms, Munitions and Implements of War (22 CFR 121-128)); the Office of Export Administration, Department of Commerce (15 CFR 370.10 (j)); the Office of Fo eign Assets Control, Department of Treasury (31 CFR Parts 500+) and the Department of Energy.

NOT GRANTED

No license under 35 U.S.C. 184 has been granted at this time, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" DOES NOT appear on this form. Applicant may still petition for a I cense under 37 CFR 5.12, if a license is desired before the expiration of 6 months from the filing date of the application. If 6 months has lapsed from the filing date of this application and the licensee has not received any ladication of a secrecy order under 35 U.S.C. 181, the licensee may foreign file the application pursuant to 37 CFR 5.15(b).